

500V Super-Junction Power MOSFET

FEATURES

- $\bullet \quad \text{Very low FOM R}_{\text{DS(on)}} \times \text{Q}_{\text{g}} \\$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information				
Device	TPA50R5K4C	TPP50R5K4C	TPU50R5K4C	TPD50R5K4C
Package	TO-220F	TO-220	TO-251	TO-252
Marking	50R5K4C	50R5K4C	50R5K4C	50R5K4C

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Barranatar		Cumbal	Value		1121
Parameter	`	Symbol	TO-220, TO-251, TO-252	TO-220F	Unit
Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	500		٧
Continuous Drain Current	uous Drain Current I _D 1		1		А
Pulsed Drain Current	(note1)	I _{DM}	3		А
Gate-Source Voltage		V_{GSS}	±30		V
Single Pulse Avalanche Energy	(note2)	E _{AS}	AS 0.45		mJ
Avalanche Current	(note1)	I _{AR}	0.3		А
Repetitive Avalanche Energy	(note1) E _{AR} 0.01		mJ		
Power Dissipation (T _C = 25°C)		P _D	5.4	2.7	W
Operating Junction and Storage Temperature Range		T_J , T_{stg}	-55~+150		°C

Thermal Resistance					
Parameter	Value			Unit	
Parameter	Symbol	TO-220, TO-251, TO-252	TO-220F	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	23	46	IZ AAI	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	80	K/W	

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TPA50R5K4C, TPP50R5K4C, TPU50R5K4C, TPD50R5K4C

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		Value				
Parameter	Symbol Test Conditions		Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	500			V
Zoro Coto Voltago Droin Current		$V_{DS} = 500V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 500V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100	μA
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.3A$		4.9	5.4	Ω
Forward Transconductance (Note3)	9 _{fs}	$V_{DS} = 10V, I_{D} = 0.3A$		0.5		S
Dynamic				•		
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 50V,$		53		pF
Output Capacitance	C _{oss}			21		
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		4		
Total Gate Charge	Q_g			1.5		nC
Gate-Source Charge	Q_{gs}	$V_{DD} = 400V, I_{D} = 1A,$ $V_{GS} = 10V$		0.3		
Gate-Drain Charge	Q_{gd}	GS -		0.6		
Turn-on Delay Time	t _{d(on)}			16		
Turn-on Rise Time	t _r	$V_{DD} = 400V, I_{D} = 1 A,$		30		
Turn-off Delay Time	t _{d(off)}	$R_G = 25\Omega$		20		ns
Turn-off Fall Time	t _f			35		
Drain-Source Body Diode Characteris	stics					
Continuous Body Diode Current	Is	T 2500			1	^
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			3	Α
Body Diode Voltage	V_{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 1A$, $V_{GS} = 0V$		0.9	1.2	V
Reverse Recovery Time	t _{rr}			35		ns
Reverse Recovery Charge	Q _{rr}	$V_R = 400V, I_F = I_S,$ $di_F/dt = 100A/\mu s$		0.1		μC
Peak Reverse Recovery Current	I _{rrm}	1,		1.4		А

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 0.3A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 1%



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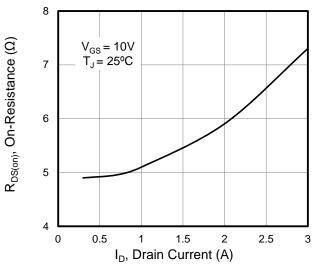
Figure 2. Transfer Characteristics

Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics 2.5 20V 10V 2 6V I_D, Drain Current (A) 5.5V 5V 1.5 4.5V 1 0.5 0 5 10 15 20 V_{DS}, Drain-to-Source Voltage (V)

 $V_{DS} = 10V$ 1.6 1.4 I_D, Drain Current (A) 1.2 $T_{J} = 25^{\circ}C$ 1 8.0 0.6 $T_{J} = 150^{\circ}C$ 0.4 0.2 0 6 0 4 10 V_{GS}, Gate-to-Source Voltage (V)

Figure 3. On-Resistance vs. Drain Current



12

10

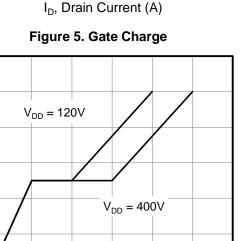
6

2

0

0

V_{GS}, Gate-to-Source Voltage (V)



0.9

Q_g, Total Gate Charge (nC)

1.2

1.5

0.6

Figure 4. Capacitance

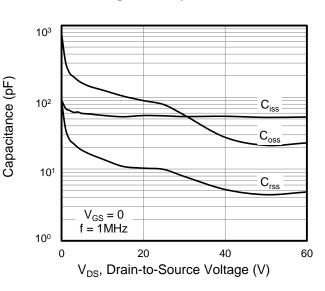
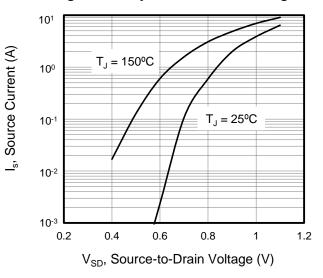


Figure 6. Body Diode Forward Voltage



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Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 7. On-Resistance vs.

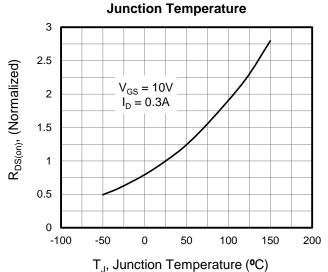


Figure 9. Transient Thermal Impedance TO-220/TO-251/TO-252

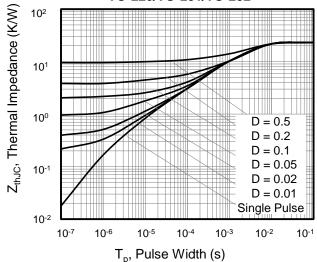
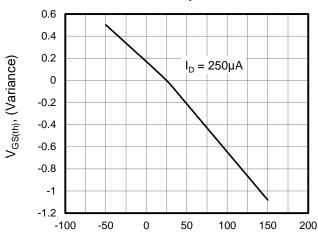
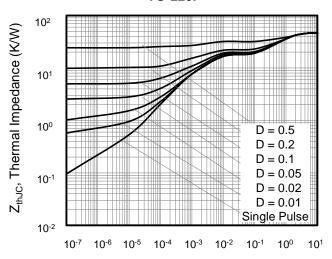


Figure 8. Threshold Voltage vs. Junction Temperature



T_J, Junction Temperature (°C)

Figure 10. Transient Thermal Impedance TO-220F



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Figure A: Gate Charge Test Circuit and Waveform

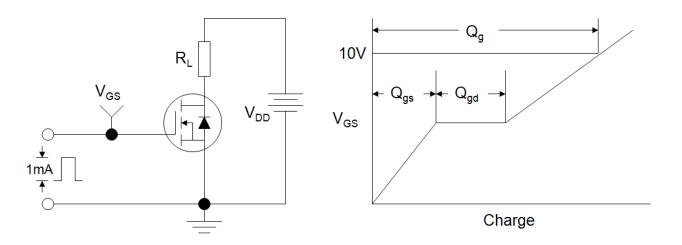


Figure B: Resistive Switching Test Circuit and Waveform

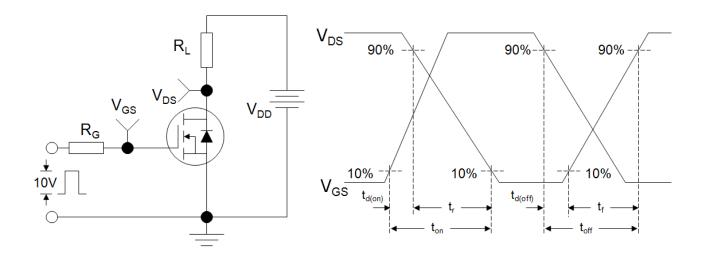
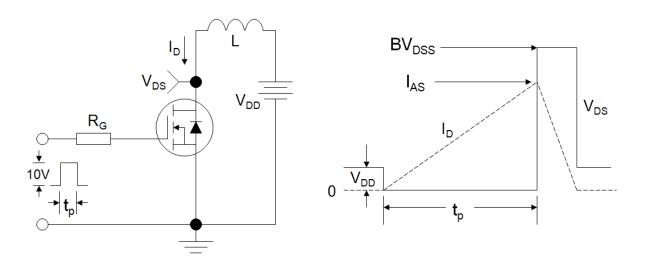


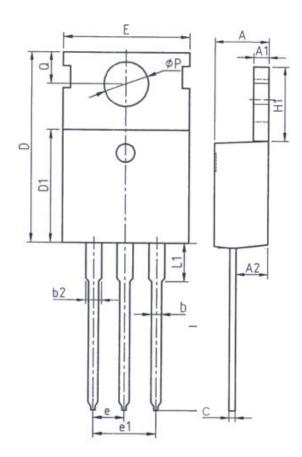
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

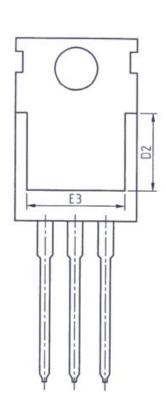


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TO-220



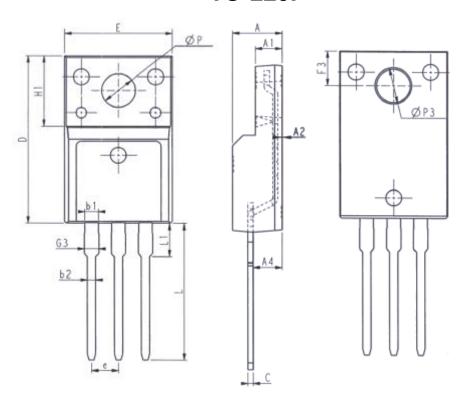


Unit: mm				
Symbol	Min.	Max.		
Α	4. 37	4. 77		
A1	1. 25	1. 45		
A2	2. 20	2. 60		
b	0. 70	0. 95		
b2	1. 17	1. 47		
С	0. 40	0. 65		
D	15. 10	16. 10		
D1	8. 80	9. 40		
D2	5. 50	_		

Unit: mm				
Symbol	Min.	Max.		
E	9. 70	10. 30		
E3	7. 00	-		
е	2. 54BSC			
e1	5. 08	BBSC		
H1	6. 25	6. 85		
L	12. 75	13.80		
L1	-	3. 40		
Р	3. 40	3. 80		
Q	2. 60	3. 00		



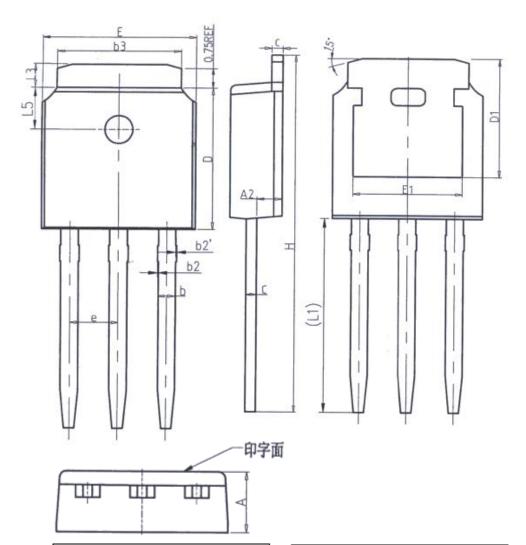




Unit: mm			l	Jnit: mn	1
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9. 96	10. 36	L	12. 68	13. 28
Α	4. 50	4. 90	L1	2. 93	3. 13
A1	2. 34	2. 74	Р	3. 03	3. 38
A2	0.30	0.60	Р3	3. 15	3. 65
A4	2. 56	2. 96	F3	3. 15	3. 45
С	0. 40	0. 65	G3	1. 25	1. 55
D	15. 57	16. 17	b1	1. 18	1. 43
H1	6. 70	DREF	b2	0. 70	0. 95
е	2. 54	4BSC			



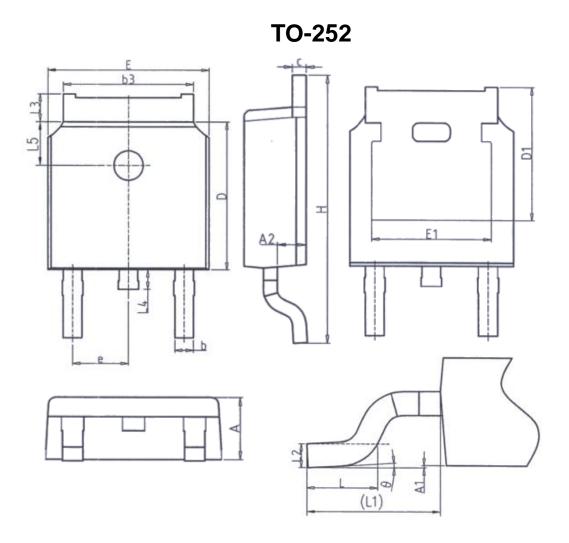
TO-251



Unit: mm				
Symbol	Min.	Max.		
Α	2. 20	2. 40		
A2	0. 97	1. 17		
b	0. 68	0.90		
b2	0.00	0.10		
b2′	0.00	0.10		
b3	5. 20	5. 50		
С	0. 43	0. 63		
D	5. 98	6. 22		

Unit: mm				
Symbol	Min.	Max.		
D1	5. 30	REF		
E	6. 40	6. 80		
E1	4. 63	-		
е	2. 286BSC			
Н	16. 22	16. 82		
L1	9. 15	9. 65		
L3	0.88	1. 28		
L5	1. 65	1. 95		





Unit: mm				
Symbol	Min.	Max.		
Α	2. 20	2. 40		
A1	0.00	0. 20		
A2	0. 97	1. 17		
b	0. 68	0. 90		
b3	5. 20	5. 50		
С	0. 43	0. 63		
D	5. 98	6. 22		
D1	5. 30	REF		
E	6. 40	6. 80		
E1	4. 63	_		

Unit: mm				
Symbol	Min.	Max.		
е	2. 28	6BSC		
Н	9. 40	10.50		
L	1. 38	1. 75		
L1	L1 2. 90REF			
L2	0. 51	IBSC		
L3	0.88	1. 28		
L4	- 1.00			
L5	1. 65	1. 95		
θ 0°		8°		

TPA50R5K4C, TPP50R5K4C, TPU50R5K4C, TPD50R5K4C



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